



Material Content Data Sheet



Sales Product Name		IPA086N10N3 G		Issued		2. August 2018		
MA#		MA000973718						
Package		PG-TO220-3-253		Weight*		2133.63 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.609	0.22	0.22	2160	2160
leadframe	non noble metal	iron	7439-89-6	1.431	0.07		671	
	inorganic material	phosphorus	7723-14-0	0.429	0.02		201	
	non noble metal	copper	7440-50-8	1428.770	66.96	67.05	669642	670514
wire	non noble metal	aluminium	7429-90-5	65.701	3.08	3.08	30793	30793
encapsulation	organic material	carbon black	1333-86-4	3.034	0.14		1422	
	plastics	epoxy resin	-	118.328	5.55		55458	
	inorganic material	silicondioxide	60676-86-0	485.446	22.75	28.44	227521	284401
leadfinish	non noble metal	tin	7440-31-5	21.462	1.01	1.01	10059	10059
plating	non noble metal	nickel	7440-02-0	1.764	0.08	0.08	827	827
solder	non noble metal	antimony	7440-36-0	0.266	0.01		125	
	noble metal	silver	7440-22-4	0.665	0.03		311	
	non noble metal	tin	7440-31-5	1.728	0.08	0.12	810	1246
*deviation	< 10%					Sum in total:	100.00	1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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